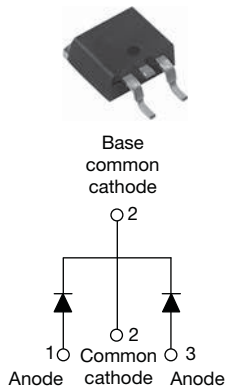
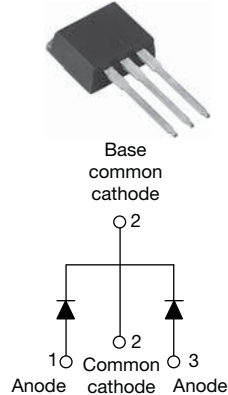


## High Performance Schottky Rectifier, 2 x 15 A

 TO-263AB (D<sup>2</sup>PAK)


VS-30CTQ...SPbF

TO-262AA



VS-30CTQ...-1PbF

### FEATURES

- 175 °C  $T_J$  operation
- Center tap configuration
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### PRODUCT SUMMARY

Package	TO-263AB (D <sup>2</sup> PAK), TO-262AA
$I_{F(AV)}$	2 x 15 A
$V_R$	80 V to 100 V
$V_F$ at $I_F$	0.67 V
$I_{RM}$	7 mA at 125 °C
$T_J$ max.	175 °C
Diode variation	Common cathode
$E_{AS}$	7.5 mJ

### DESCRIPTION

This center tap Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform	30	A
$V_{RRM}$		80/100	V
$I_{FSM}$	$t_p = 5 \mu s$ sine	850	A
$V_F$	15 A <sub>pk</sub> , $T_J = 125 \text{ °C}$ (per leg)	0.67	V
$T_J$	Range	-55 to 175	°C

### VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-30CTQ080SPbF VS-30CTQ080-1PbF	VS-30CTQ100SPbF VS-30CTQ100-1PbF	UNITS
Maximum DC reverse voltage	$V_R$	80	100	V
Maximum working peak reverse voltage	$V_{RWM}$			

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current, see fig. 5	$I_{F(AV)}$	50 % duty cycle at $T_C = 129 \text{ °C}$ , rectangular waveform	30	A
			15	
Maximum peak one cycle non-repetitive surge current per leg, see fig. 7	$I_{FSM}$	5 $\mu s$ sine or 3 $\mu s$ rect. pulse	850	A
		10 ms sine or 6 ms rect. pulse	275	
Non-repetitive avalanche energy per leg	$E_{AS}$	$T_J = 25 \text{ °C}$ , $I_{AS} = 0.50 \text{ A}$ , $L = 60 \text{ mH}$	7.50	mJ
Repetitive avalanche current per leg	$I_{AR}$	Current decaying linearly to zero in 1 $\mu s$ Frequency limited by $T_J$ maximum $V_A = 1.5 \times V_R$ typical	0.50	A



ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop per leg See fig. 1	$V_{FM}^{(1)}$	15 A	$T_J = 25\text{ }^\circ\text{C}$	0.86	V
		30 A		1.05	
		15 A	$T_J = 125\text{ }^\circ\text{C}$	0.67	
		30 A		0.82	
Maximum reverse leakage current per leg See fig. 2	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	$V_R = \text{Rated } V_R$	0.55	mA
		$T_J = 125\text{ }^\circ\text{C}$		7.0	
Maximum junction capacitance per leg	$C_T$	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), $25\text{ }^\circ\text{C}$		500	pF
Typical series inductance per leg	$L_S$	Measured lead to lead 5 mm from package body		8.0	nH
Maximum voltage rate of change	dV/dt	Rated $V_R$		10 000	V/ $\mu$ s

**Note**(1) Pulse width < 300  $\mu$ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$			-55 to +175	$^\circ\text{C}$
Maximum thermal resistance, junction to case per leg	$R_{thJC}$	DC operation		3.25	$^\circ\text{C}/\text{W}$
Maximum thermal resistance, junction to case per package				1.63	
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased		0.50	
Approximate weight				2	g
				0.07	oz.
Mounting torque	minimum			6 (5)	kgf · cm (lbf · in)
	maximum			12 (10)	
Marking device		Case style TO-263AB (D <sup>2</sup> PAK)		30CTQ100S	
		Case style TO-262AA		30CTQ100-1	

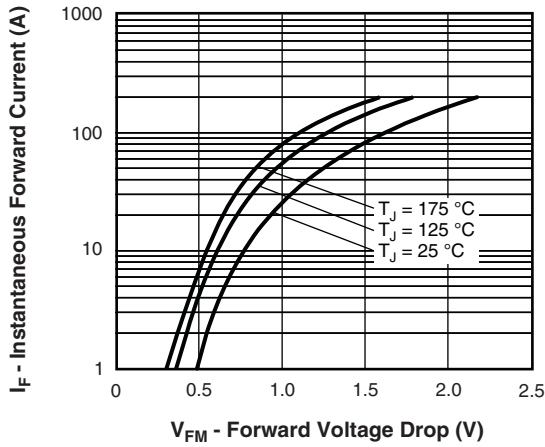


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

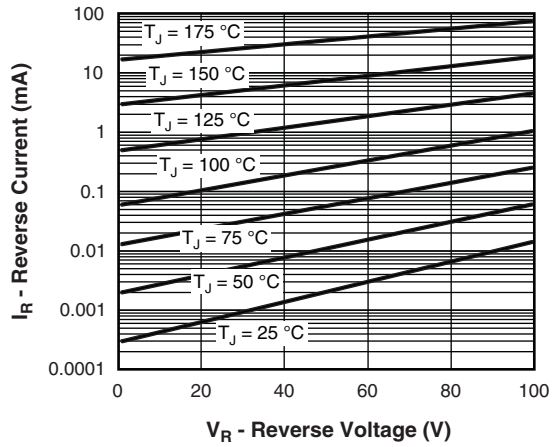


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

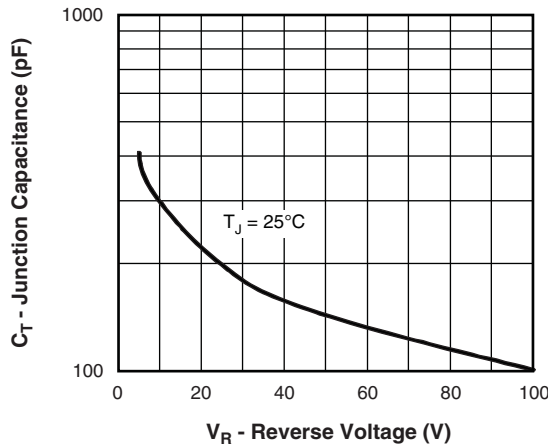


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

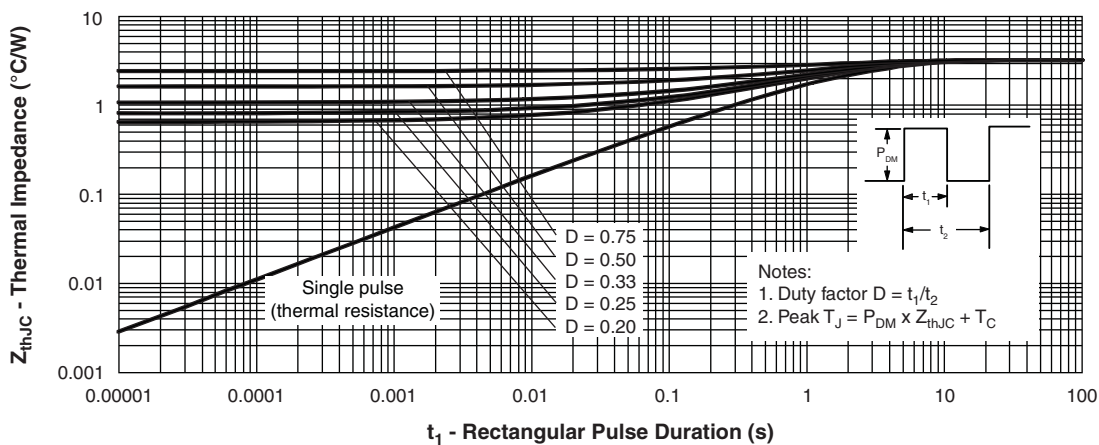


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

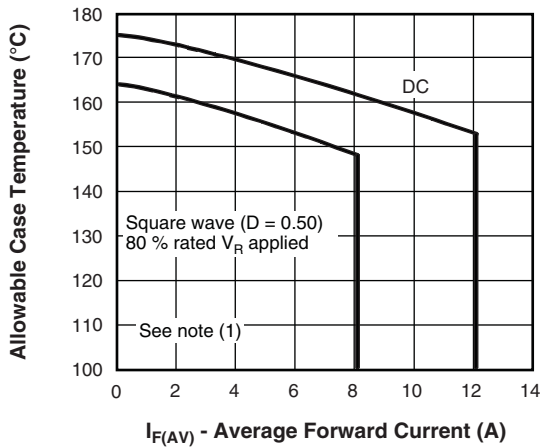


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

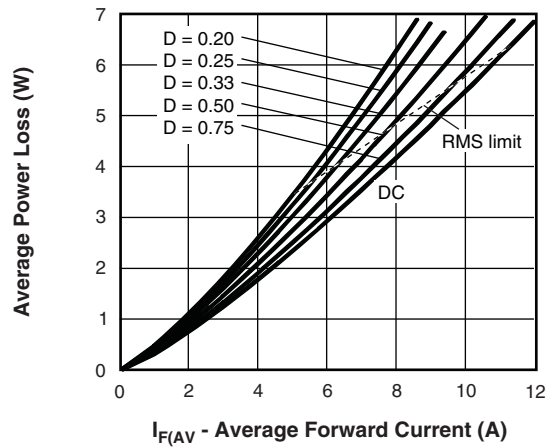


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

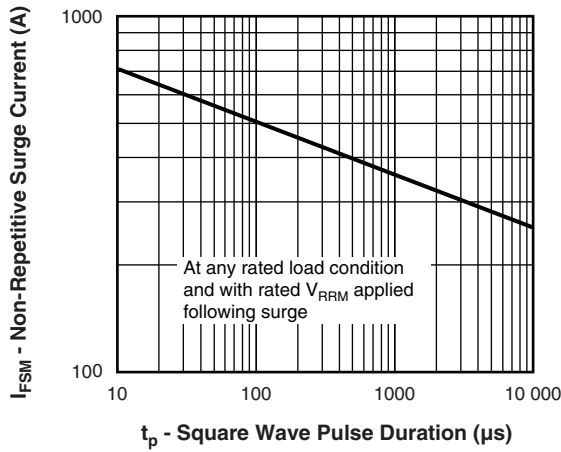


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

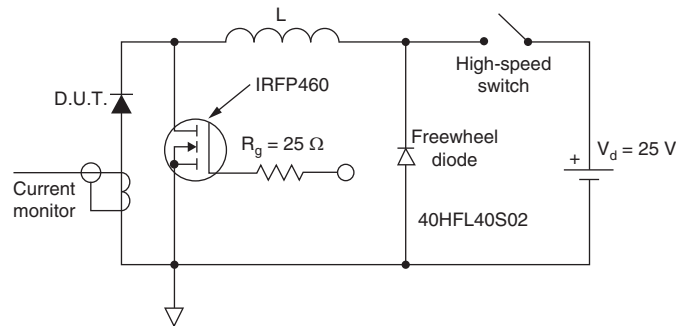


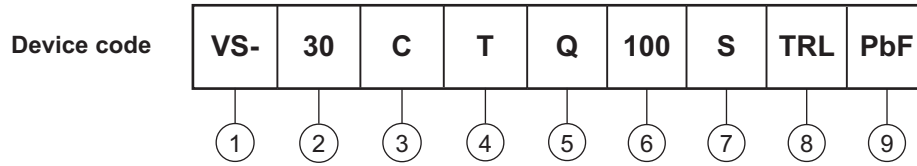
Fig. 8 - Unclamped Inductive Test Circuit

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$ ;
- $P_d$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);
- $P_{d_{REV}}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1} = 10 V$



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (30 A)
- 3** - Circuit configuration: C = common cathode
- 4** - T = TO-220
- 5** - Schottky "Q" series
- 6** - Voltage ratings
 

080 = 80 V
100 = 100 V
- 7** -
  - S = D<sup>2</sup>PAK
  - -1 = TO-262
- 8** -
  - None = tube (50 pieces)
  - TRL = tape and reel (left oriented - for D<sup>2</sup>PAK only)
  - TRR = tape and reel (right oriented - for D<sup>2</sup>PAK only)
- 9** - PbF = lead (Pb)-free

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-30CTQ080SPBF	50	1000	Antistatic plastic tubes
VS-30CTQ080STRRPBF	800	800	13" diameter plastic tape and reel
VS-30CTQ080STRLPBF	800	800	13" diameter plastic tape and reel
VS-30CTQ080-1PBF	50	1000	Antistatic plastic tubes
VS-30CTQ090SPBF	50	1000	Antistatic plastic tubes
VS-30CTQ090STRRPBF	800	800	13" diameter plastic tape and reel
VS-30CTQ090STRLPBF	800	800	13" diameter plastic tape and reel
VS-30CTQ090-1PBF	50	1000	Antistatic plastic tubes
VS-30CTQ100SPBF	50	1000	Antistatic plastic tubes
VS-30CTQ100STRRPBF	800	800	13" diameter plastic tape and reel
VS-30CTQ100STRLPBF	800	800	13" diameter plastic tape and reel
VS-30CTQ100-1PBF	50	1000	Antistatic plastic tubes

LINKS TO RELATED DOCUMENTS					
Dimensions	<table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%; text-align: center;">TO-263AB (D<sup>2</sup>PAK)</td> <td style="text-align: center;"><a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a></td> </tr> <tr> <td style="text-align: center;">TO-262AA</td> <td style="text-align: center;"><a href="http://www.vishay.com/doc?95419">www.vishay.com/doc?95419</a></td> </tr> </table>	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a>	TO-262AA	<a href="http://www.vishay.com/doc?95419">www.vishay.com/doc?95419</a>
TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a>				
TO-262AA	<a href="http://www.vishay.com/doc?95419">www.vishay.com/doc?95419</a>				
Part marking information	<a href="http://www.vishay.com/doc?95008">www.vishay.com/doc?95008</a>				
Packaging information	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>				

## D<sup>2</sup>PAK, TO-262

### DIMENSIONS FOR D<sup>2</sup>PAK in millimeters and inches

Conforms to JEDEC outline D<sup>2</sup>PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
H	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010 BSC		
L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

- (7) Outline conforms to JEDEC outline TO-263AB

## DIMENSIONS FOR TO-262 in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



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